IPC - ASSOCIATION CONNECTING ELECTRONICS INDUSTRIE	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			der both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				Form Type Distribute	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					ials and Mfe Information				
upplier Inform	nation														
Company name*			Company unique ID			J	Unique ID Authority				Response Date*				
nsemi											2025-06-08				
Contact Name			Title - Contact			I	Phone - Contact*				Email - Contact*				
Product-Env-Stewa	ards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
authorized Represe	entative*	Title - Representative			I	Phone - Representative*				Email - Representative*					
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Requeste	Requester Item Number Mfr		Mfr Item Number Mfr Item Name			Effec		Version	N	Manufacturing Site	V	Veight*	UOM	Unit Type	
		NIV6350MT2TXG 5V Electroni		5V Electronic Fuse-	FuseAuto Retry		2025-06-08		N	MY1		4.86	mg	Each	
	Process Informatio		amain al Daga	Allow	STD-020 MSL	Dating	Dools Duo	aga Dadu T		Mov Time at Peak	Tomorous	Mumb	per of Reflow Cyc	alac	
1			Terminal Base Alloy J-ST CU Alloy 1		S I D-020 MSL	. Kating	Peak Process Body Temp		T *				ber of Reflow Cyc	cies	
•	n (Sn) - anneaied	C	U Alloy	1			200		<u>IC</u>	30	second	ls 3			
omments	ima at neels townswature	duning sale	domina ia 10-2	20 seconds											
	ime at peak temperature														
<i>r</i> more informati	on regarding material co	mposition p	please refer to	o page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have not with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.74	mg	Supplier	Silicon (Si)	7440-21-3		0.74	mg
Die Attach Tape	0.57	mg		Epoxy resin	proprietary data		0.399	mg
			Supplier	Acrylic resins	Proprietary Data		0.171	mg
Lead Frame	11.8		Supplier	Silver (Ag)	7440-22-4		0.236	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0118	mg
			Supplier	Iron (Fe)	7439-89-6		0.2596	mg
			Supplier	Copper (Cu)	7440-50-8		11.2926	mg
Mold Compound-Black	11.0		Supplier	Silica Amorphous (SiO2)	7631-86-9		0.825	mg
			Supplier	Carbon Black (C)	1333-86-4		0.055	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		8.745	mg
			Supplier	EpoxyNovolaCresins (Cresolic)	64425-89-4		0.55	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.825	mg
Plating	0.71	mg	Supplier	Tin (Sn)	7440-31-5		0.71	mg
Wire Bond	0.04		Supplier	Palladium (Pd)	7440-05-3		0.0004	mg
			Supplier	Copper (Cu)	7440-50-8		0.0396	mg